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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shinji YAMAMOTO	03/30/2012
Masaaki ISHIO	03/30/2012

RECEIVING PARTY DATA

Name:	NEOMAX MATERIALS CO., LTD.	
Street Address:	2-19-1, Minamisuita	
City:	Suita-shi, Osaka	
State/Country:	JAPAN	
Postal Code:	564-0043	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13501533

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 60303.105/HO

NAME OF SUBMITTER: Satoko Sakiyama

Total Attachments: 1

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PATENT

REEL: 028034 FRAME: 0917

Attorney Docket No.: 60303.

ASSIGNMENT (WORLDWIDE)

WHEREAS, We, Shinji YAMAMOTO and Masaaki ISHIO (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled ALUMINUM BONDING ALLOY, AND CLAD MATERIAL AND ALUMINUM BONDING COMPOSITE MATERIAL EACH HAVING BONDING ALLOY LAYER MADE OF THE				
ALLOY for	executed on even date herev	Patent of the United States has been vith; as Serial No. 13/501,533		
WHEREAS, NEOMAX MATERIALS CO., LTD. 2-19-1, Minamisuita, Suita-shi, Osaka 564-0043, Japan (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;				
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.				
		no assignment, sale, agreement or encumbrance lich would conflict with this assignment and sale;		
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.				
Dated: Marcl	n 30 ,2012	Shinji YAMAMOTO		
Dated: <u>Marcl</u>	n 30 ,2012	Masaaki ISHIO		

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